# AMENDMENTS TO THE CLAIMS

# Please amend the claims, as follows:

- 1. (Previously Presented) An electrode for a p-type SiC, comprising a first electrode material, and a second electrode material of aluminum (Al), said first and second electrode materials exhibiting an eutectic reaction at a temperature of 600°C or lower, wherein a layer made of said first electrode material is in contact with a surface of the p-type SiC.
- 2. (Previously Presented) An electrode for a p-type SiC according to claim 1, wherein said first electrode material comprises germanium (Ge).
- 3. (Previously Presented) An electrode for a p-type SiC according to claim 2, further comprising a third electrode material of titanium (Ti).

### 4. (Canceled)

- 5. (Previously presented) An electrode for a p-type SiC, comprising a first layer of germanium (Ge), and a second layer of aluminum (Al), wherein said first and second layers are formed successively on the p-type SiC and said first layer is in contact with a surface of the p-type SiC, the first layer and second layer exhibiting a eutectic reaction at a temperature of 600°C or lower.
- 6. (Previously Presented) An electrode for a p-type SiC according to claim 5, further comprising a third layer of titanium (Ti) formed between said first and second layers.
- 7. (Previously Presented) An SiC device including a p-type SiC, and an electrode for the p-type SiC defined in claim 1 and formed on said p-type SiC.
- 8. (Previously Presented) An SiC device including a p-type SiC, and an electrode for the p-type SiC defined in claim 2 and formed on said p-type SiC.

9. (Previously Presented) An SiC device including a p-type SiC, and an electrode for the p-type SiC defined in claim 3 and formed on said p-type SiC.

# 10. (Canceled)

- 11. (Previously Presented) An SiC device including a p-type SiC, and an electrode for the p-type SiC defined in claim 5 and formed on said p-type SiC.
- 12. (Previously Presented) An SiC device including a p-type SiC, and an electrode for the p-type SiC defined in claim 6 and formed on said p-type SiC.

#### 13-24. (Canceled)

- 25. (Previously Presented) An electrode for a p-type SiC according to claim 1, further comprising an ohmic junction formed between the p-type SiC and the first electrode material.
- 26. (Previously Presented) An electrode for a p-type SiC, comprising:

  means for accelerating a eutectic reaction at a temperature of 600°C or lower;

  first means for reducing contact resistivity; and

  second means for reducing contact resistivity, wherein the first means for
  reducing contact resistivity comprises a different component than the second means for
  reducing contact resistivity.
- 27. (Previously Presented) An electrode for a p-type SiC according to claim 26, wherein the means for accelerating a eutectic reaction comprises a layer disposed on a surface of the p-type SiC.
- 28. (Previously Presented) An electrode for a p-type SiC according to claim 26, wherein the second means for reducing contact resistivity is disposed between the means for

accelerating a eutectic reaction and the first means for reducing contact resistivity.

- 29. (Previously Presented) An electrode for a p-type SiC according to claim 26, further comprising an ohmic junction between the means for accelerating a eutectic reaction and a surface of the p-type SiC.
- 30. (Previously Presented) An electrode for a p-type SiC according to claim 26, wherein the means for accelerating the eutectic reaction further comprises means for solidifying a mixture of Ge, Al, and Ti at 600°C or lower.
- 31. (Previously Presented) An electrode for a p-type SiC according to claim 26, further comprising means for suppressing thermal damage to the electrode during heat treatment.
- 32. (Previously Presented) An electrode for a p-type SiC according to claim 29, further comprising means for increasing current flow through the ohmic junction.
- 33. (New) An electrode for a p-type SiC according to claim 1, wherein a thickness of said first material is approximately 60 nm and a thickness of said aluminum is approximately 360 nm.
- 34. (New) An electrode for a p-type SiC according to claim 3, wherein a thickness of said germanium material is approximately 60 nm, a thickness of said aluminum is approximately 360 nm, and a thickness of said titanium is approximately 80 nm.